

0.05 $\mu\text{V}/^\circ\text{C}$ MAX, SINGLE-SUPPLY CMOS OPERATIONAL AMPLIFIER ZERO-DRIFT SERIES

FEATURES

- **Low Offset Voltage:** 5 μV (max)
- **Zero Drift:** 0.02 $\mu\text{V}/^\circ\text{C}$ (typ)
- **Quiescent Current:** 570 μA
- **Single-Supply Operation**
- **Ceramic DIP Package**

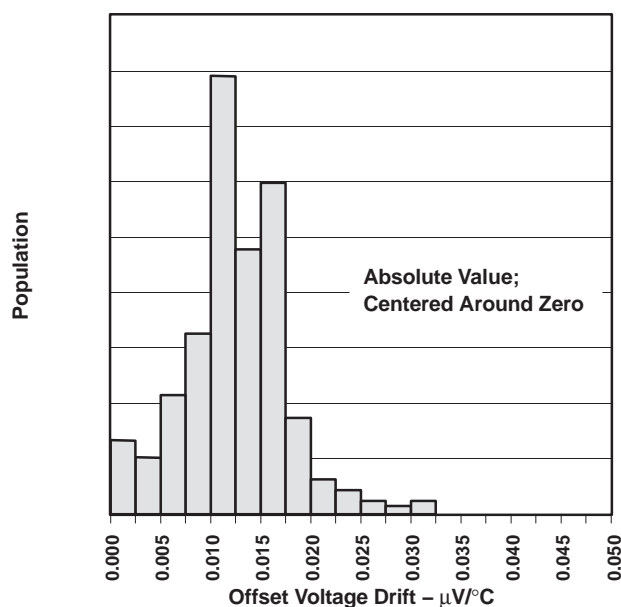
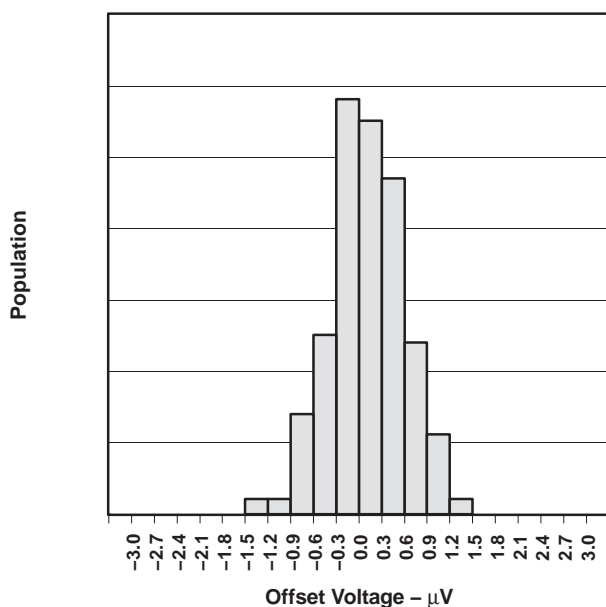
APPLICATIONS

- **Transducer Applications**
- **Temperature Measurement**
- **Electronic Scales**
- **Medical Instrumentation**
- **Battery-Powered Instruments**
- **Handheld Test Equipment**

DESCRIPTION

The OPA2335 CMOS operational amplifier uses auto-zeroing techniques to simultaneously provide very low offset voltage (5 μV max), and near-zero drift over time and temperature. This high-precision, low quiescent current amplifier offers high input impedance and rail-to-rail output swing. Single or dual supplies as low as 2.7 V (± 1.35 V) and up to 5.5 V (± 2.75 V) may be used. This op amp is optimized for low-voltage, single-supply operation.

The OPA2335 is available in a CDIP-8 package and is specified for operation from -55°C to 125°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



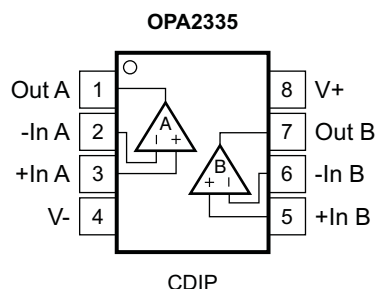
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

| PRODUCT | PACKAGE LEAD | PACKAGE DESIGNATOR | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER |
|---------|--------------|--------------------|-----------------------------|-----------------|-----------------|
| OPA2335 | CDIP-8 | JG | –55°C to 125°C | OPA2335AMJG | OPA2335AMJG |

PIN CONFIGURATIONS



P0037-01

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | VALUE | UNIT |
|--------------------------------------|------------------------|--------------------|------|
| Supply voltage | | 7 V | |
| Signal input terminals | Voltage ⁽²⁾ | –0.5 to (V+) + 0.5 | V |
| | Current ⁽²⁾ | ±10 | mA |
| Output short circuit ⁽³⁾ | | Continuous | |
| Operating temperature T _A | | –55 to 150 | °C |
| Storage temperature T _A | | –65 to 150 | °C |
| Junction temperature | | 150 | °C |
| Lead temperature (soldering, 10s) | | 300 | °C |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these, or any other conditions beyond those specified, is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5 V beyond the supply rails should be current-limited to 10 mA or less.
- (3) Short-circuit to ground, one amplifier per package

ELECTRICAL CHARACTERISTICS

At T_A = 25°C, V_S = +5 V, R_L = 10 kΩ connected to V_S/2, and V_{OUT} = V_S/2 (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|----------------------|-------------------------------------|-----------------------|-------|-----|-------|
| OFFSET VOLTAGE | | | | | | |
| Input offset voltage | V _{OS} | V _{CM} = V _S /2 | T _A = 25°C | 1 | 5 | μV |
| | | | | | 10 | |
| vs Temperature | dV _{OS} /dT | | | ±0.02 | | μV/°C |

ELECTRICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$ (unless otherwise noted)

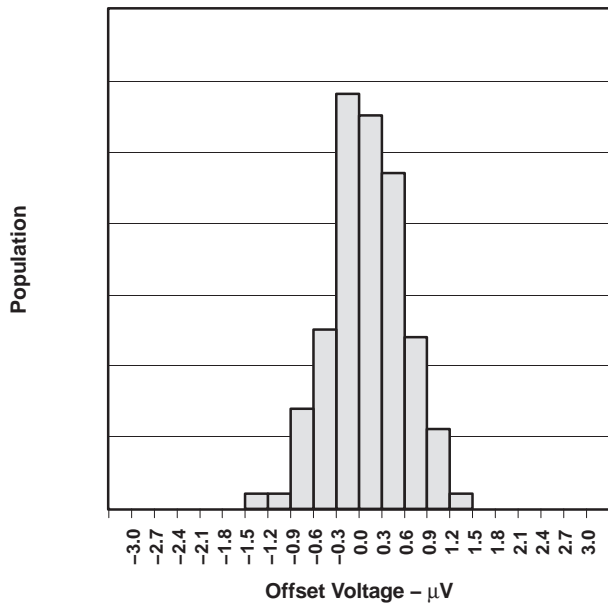
| PARAMETER | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---|---------------|--|---------------------------|-----------------------------|-----------|---------|------------------------------|
| vs Power supply | PSSR | $V_S = 2.7\text{ V to }5.5\text{ V}$ | | ± 1 | | ± 2 | $\mu\text{V/V}$ |
| Long-term stability | | | | See Note ⁽¹⁾ | | | |
| Channel separation, dc | | | | 0.1 | | | $\mu\text{V/V}$ |
| INPUT BIAS CURRENT | | | | | | | |
| Input bias current | I_B | $V_{CM} = V_S/2$ | $T_A = 25^\circ\text{C}$ | ± 70 | ± 200 | | pA |
| | | | $T_A = \text{Full range}$ | 1 | | | nA |
| Input offset current | I_{OS} | | | ± 120 | ± 400 | | pA |
| NOISE | | | | | | | |
| Input voltage noise | e_n | $f = 0.01\text{ Hz to }10\text{ Hz}$ | | 1.4 | | | μVpp |
| Input current noise density | i_n | $f = 10\text{ Hz}$ | | 20 | | | $\text{fA}/\sqrt{\text{Hz}}$ |
| INPUT VOLTAGE RANGE | | | | | | | |
| Common-mode voltage range | V_{CM} | | | (V−) −0.1 | (V+) −1.5 | | V |
| Common-mode rejection ratio | CMRR | $(V-) - 0.1\text{ V} < V_{CM} < (V+) - 1.5\text{ V}$ | $T_A = 25^\circ\text{C}$ | 110 | 130 | | dB |
| | | $(V-) < V_{CM} < (V+) - 1.5\text{ V}$ | $T_A = \text{Full range}$ | 110 | 130 | | dB |
| INPUT CAPACITANCE | | | | | | | |
| Differential | | | | 1 | | | pF |
| Common-mode | | | | 5 | | | pF |
| OPEN-LOOP GAIN | | | | | | | |
| Open-loop voltage gain | A_{OL} | $50\text{ mV} < V_O < (V+) - 50\text{ mV}$, $R_L = 100\text{ k}\Omega$, $V_{CM} = V_S/2$ | $T_A = \text{Full range}$ | 110 | 130 | | dB |
| | | $100\text{ mV} < V_O < (V+) - 100\text{ mV}$, $R_L = 10\text{ k}\Omega$, $V_{CM} = V_S/2$ | $T_A = \text{Full range}$ | 110 | 130 | | dB |
| FREQUENCY RESPONSE | | | | | | | |
| Gain-Bandwidth Product | GBW | | | 2 | | | MHz |
| Slew Rate | SR | $G = +1$ | | 1.6 | | | $\text{V}/\mu\text{s}$ |
| OUTPUT | | | | | | | |
| Voltage output swing from rail | | $R_L = 10\text{ k}\Omega$ | $T_A = \text{Full range}$ | 15 | 100 | | mV |
| | | $R_L = 100\text{ k}\Omega$ | $T_A = \text{Full range}$ | 1 | 50 | | mV |
| Short-circuit current | I_{SC} | | | ± 50 | | | mA |
| Capacitive load drive | C_{LOAD} | | | See Typical Characteristics | | | |
| POWER SUPPLY | | | | | | | |
| Operating voltage range | | | | 2.7 | 5.5 | | V |
| Quiescent current (total-2 amplifiers) | I_Q | $I_O = 0$, $V_S = +5\text{ V}$ | $T_A = 25^\circ\text{C}$ | 570 | 700 | | μA |
| | | | $T_A = \text{Full range}$ | 900 | | | μA |
| TEMPERATURE RANGE | | | | | | | |
| Operating range | T_A | | | −55 | 125 | | $^\circ\text{C}$ |
| Storage range | | | | −65 | 150 | | $^\circ\text{C}$ |
| Thermal resistance | θ_{JA} | | | 119 | | | $^\circ\text{C/W}$ |

(1) 500-hour life test at 150°C demonstrated randomly distributed variation approximately equal to measurement repeatability of $1\text{ }\mu\text{V}$.

TYPICAL CHARACTERISTICS

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$ and $V_{OUT} = V_S/2$ (unless otherwise noted)

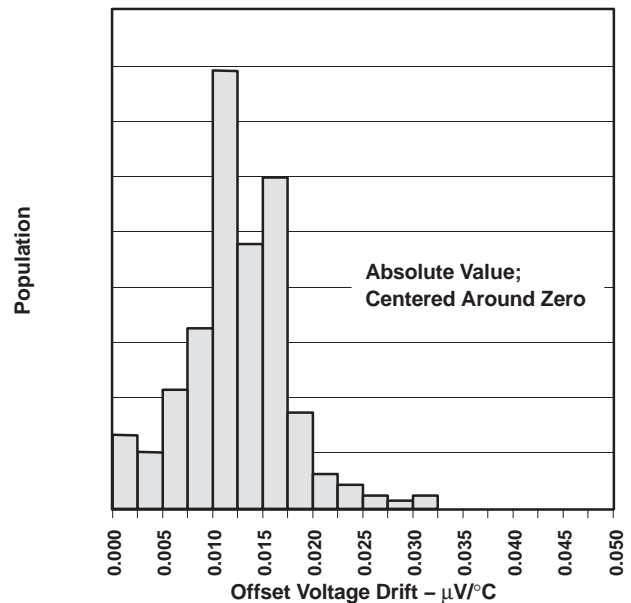
OFFSET VOLTAGE PRODUCTION DISTRIBUTION



G001

Figure 1.

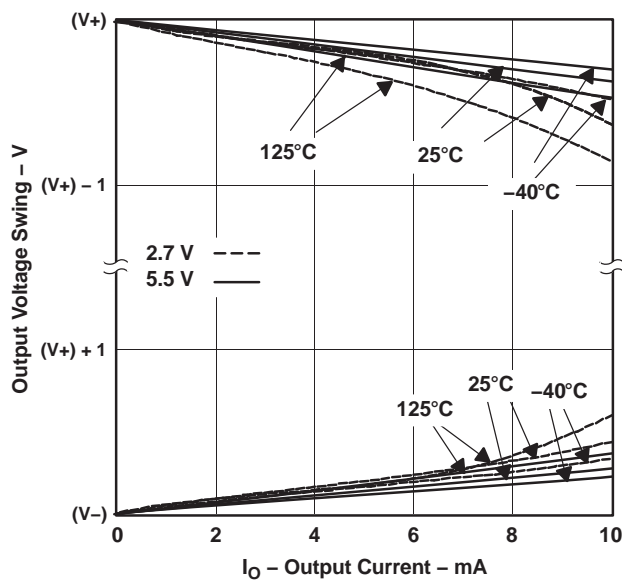
OFFSET VOLTAGE DRIFT PRODUCTION DISTRIBUTION



G002

Figure 2.

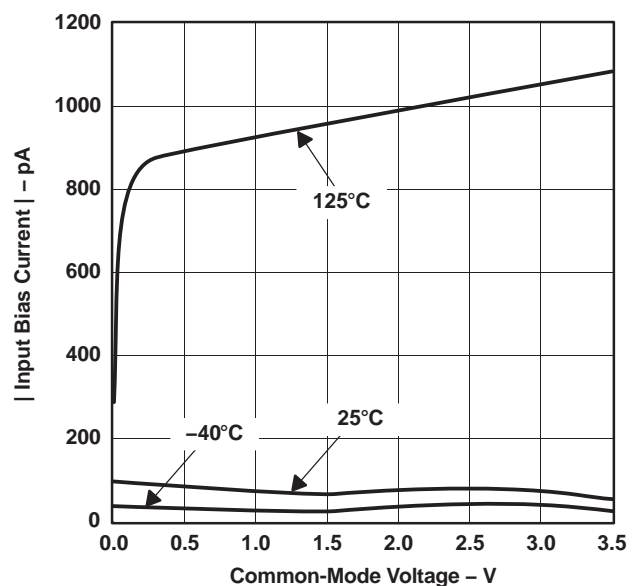
OFFSET VOLTAGE SWING
vs
OUTPUT CURRENT



G003

Figure 3.

INPUT BIAS CURRENT
vs
COMMON-MODE VOLTAGE

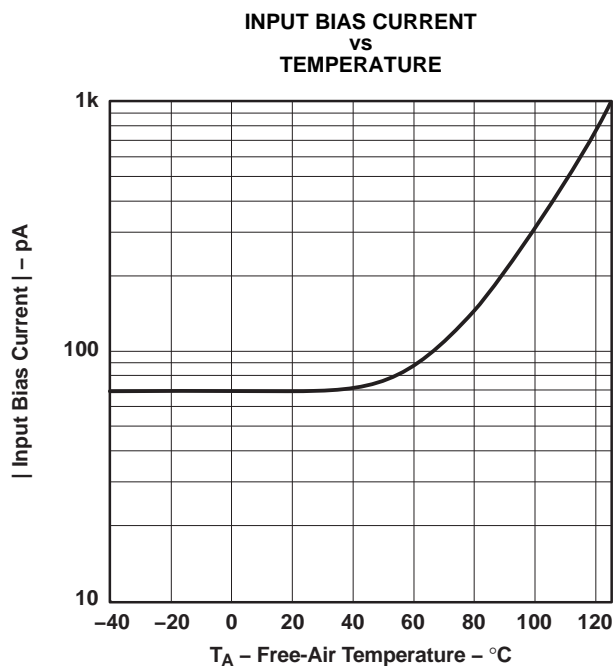


G004

Figure 4.

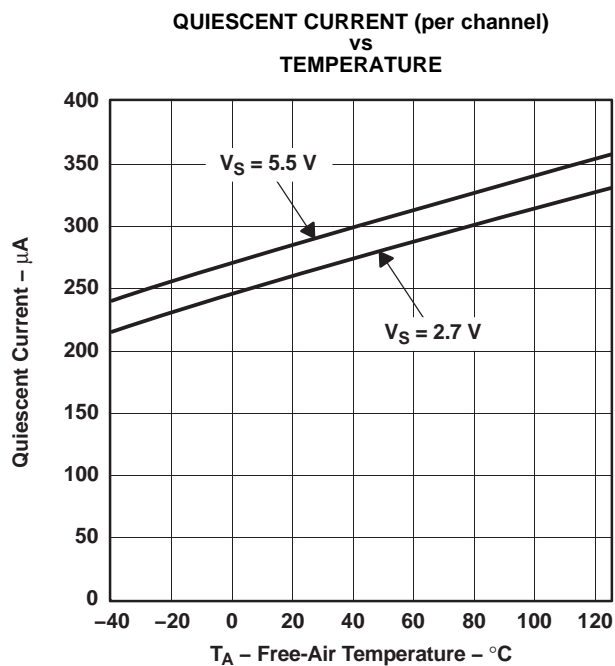
TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$ and $V_{OUT} = V_S/2$ (unless otherwise noted)



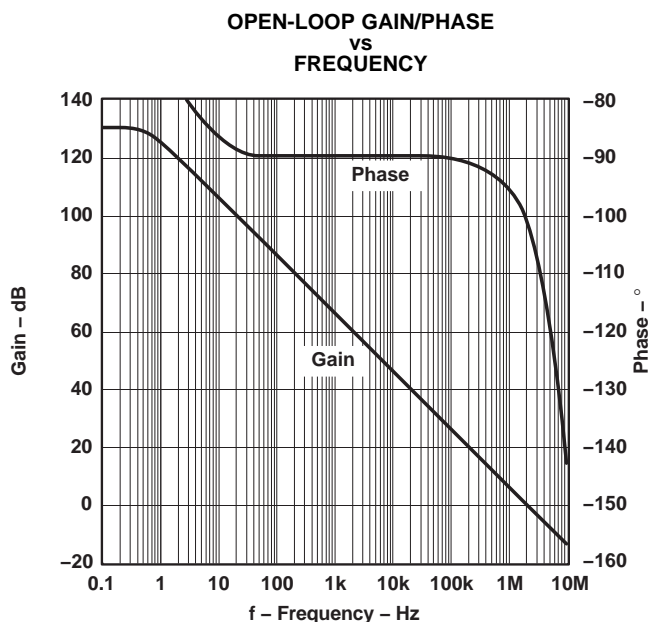
G005

Figure 5.



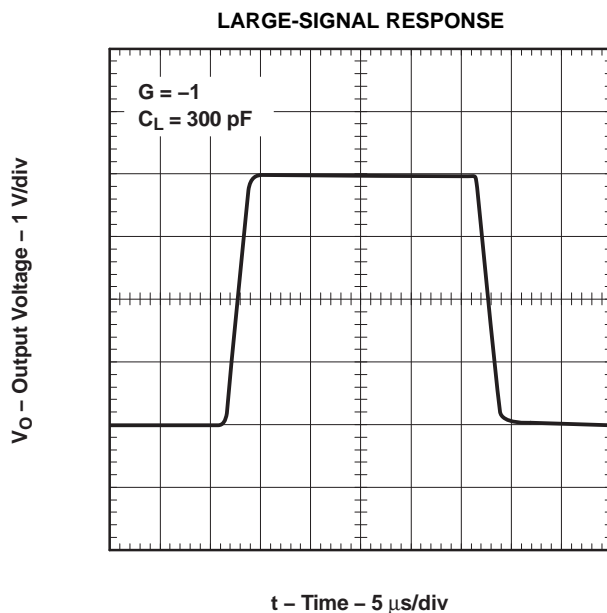
G006

Figure 6.



G007

Figure 7.



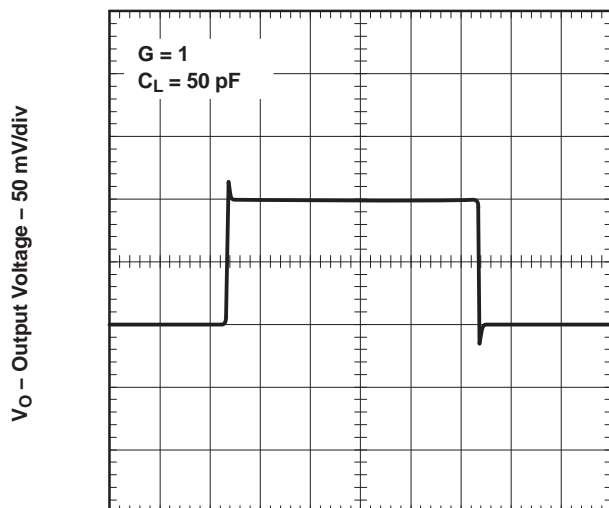
G008

Figure 8.

TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$ and $V_{OUT} = V_S/2$ (unless otherwise noted)

SMALL-SIGNAL RESPONSE

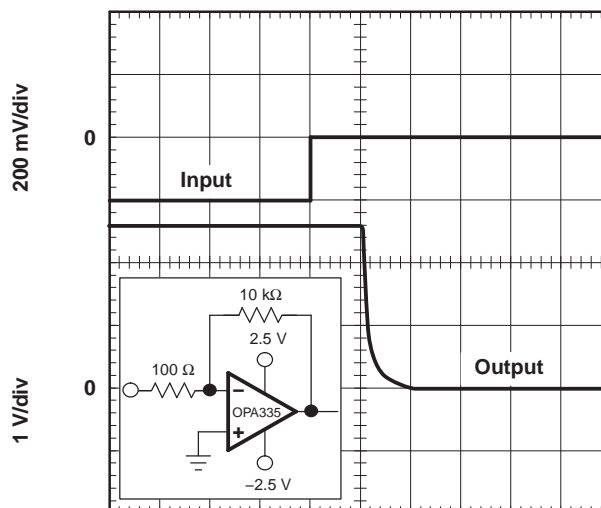


$t - \text{Time} - 5\text{ }\mu\text{s/div}$

G009

Figure 9.

POSITIVE OVER-VOLTAGE RECOVERY

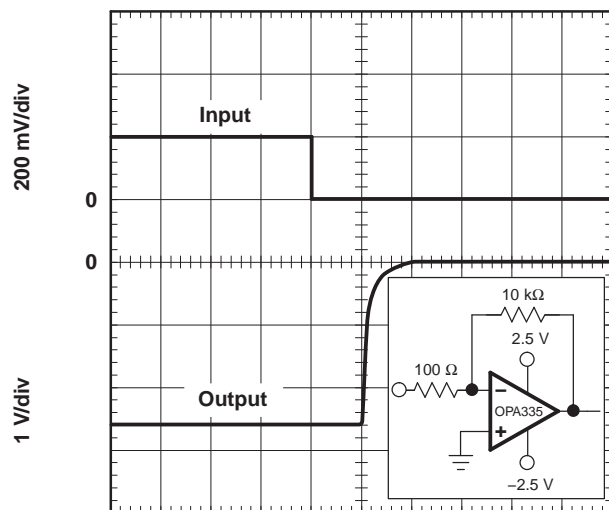


$t - \text{Time} - 25\text{ }\mu\text{s/div}$

G010

Figure 10.

NEGATIVE OVER-VOLTAGE RECOVERY



$t - \text{Time} - 25\text{ }\mu\text{s/div}$

G011

Figure 11.

COMMON-MODE REJECTION vs FREQUENCY

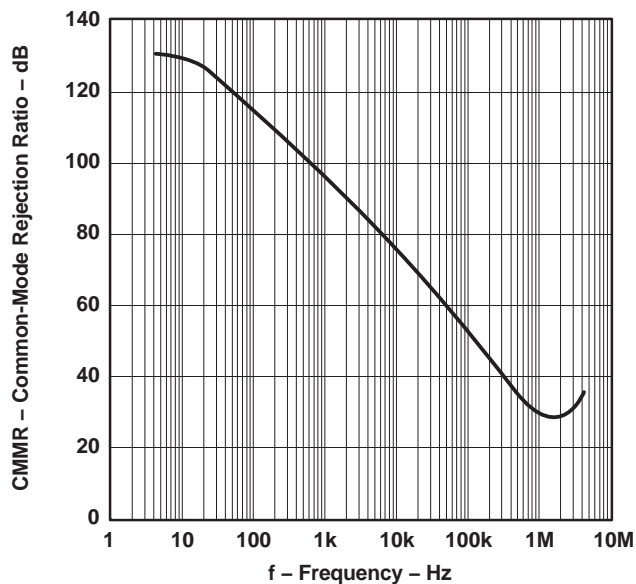
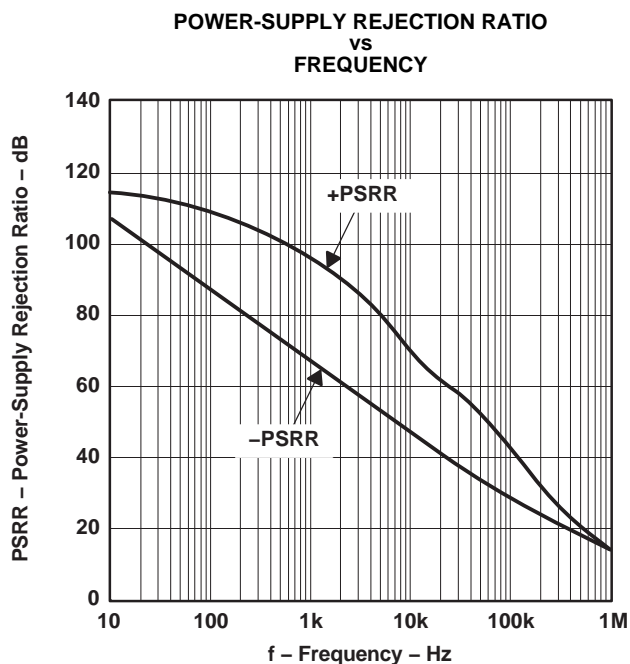


Figure 12.

G012

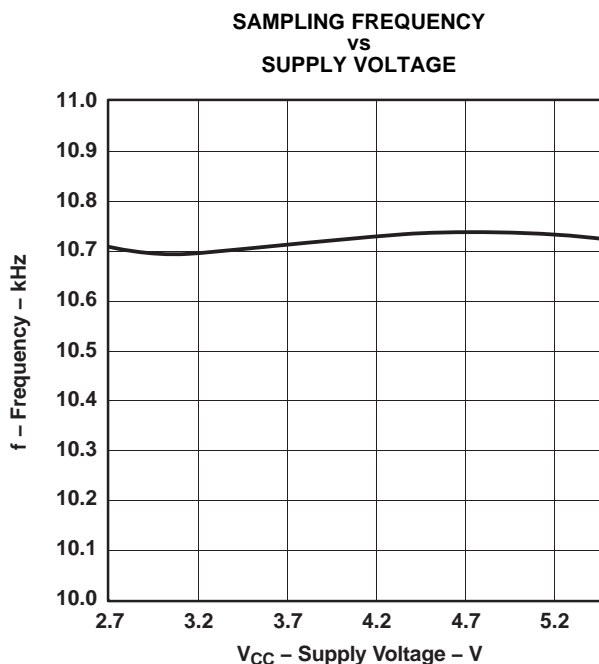
TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$ and $V_{OUT} = V_S/2$ (unless otherwise noted)



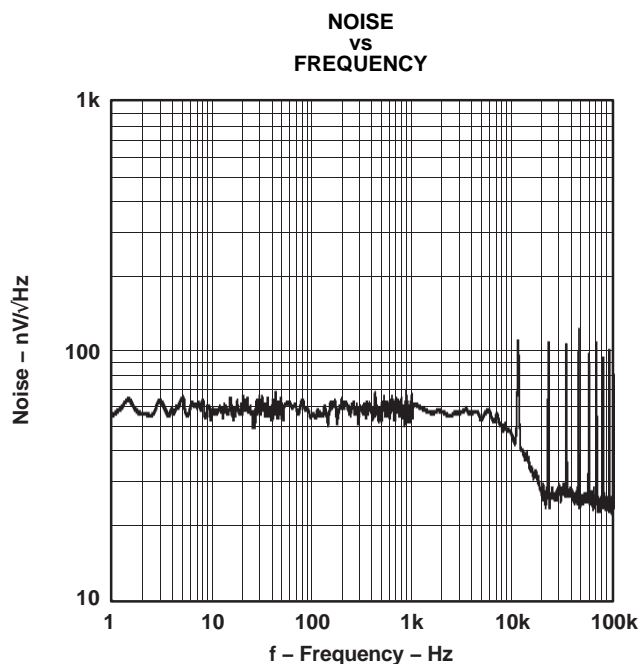
G013

Figure 13.



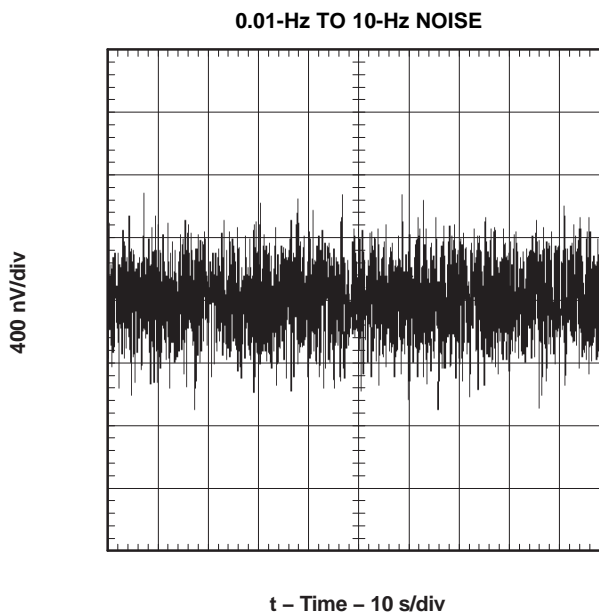
G014

Figure 14.



G015

Figure 15.



G016

Figure 16.

TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $V_S = +5\text{ V}$, $R_L = 10\text{ k}\Omega$ connected to $V_S/2$ and $V_{OUT} = V_S/2$ (unless otherwise noted)

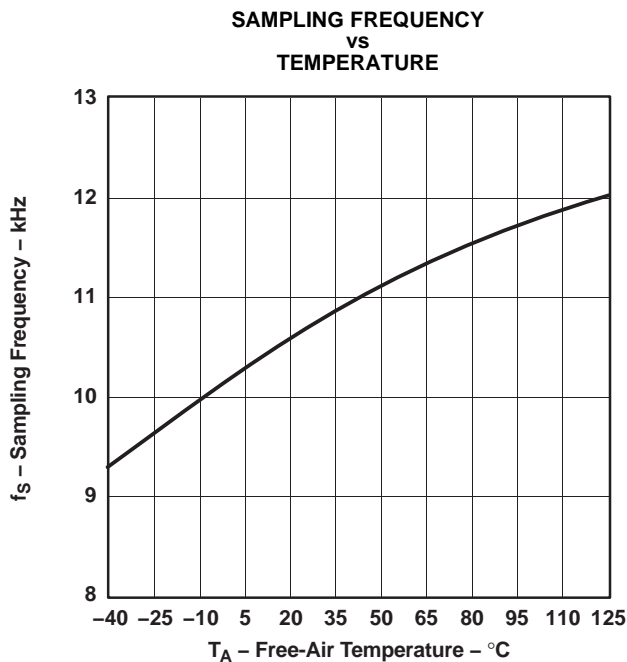


Figure 17.

G017

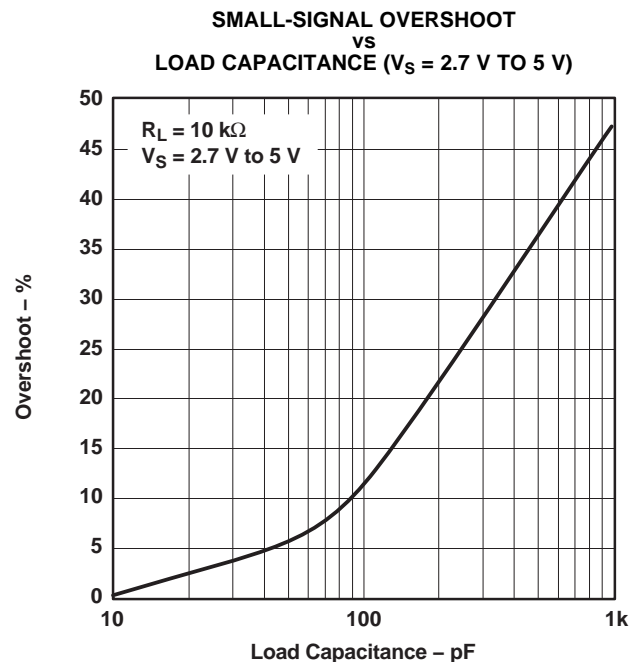


Figure 18.

G018

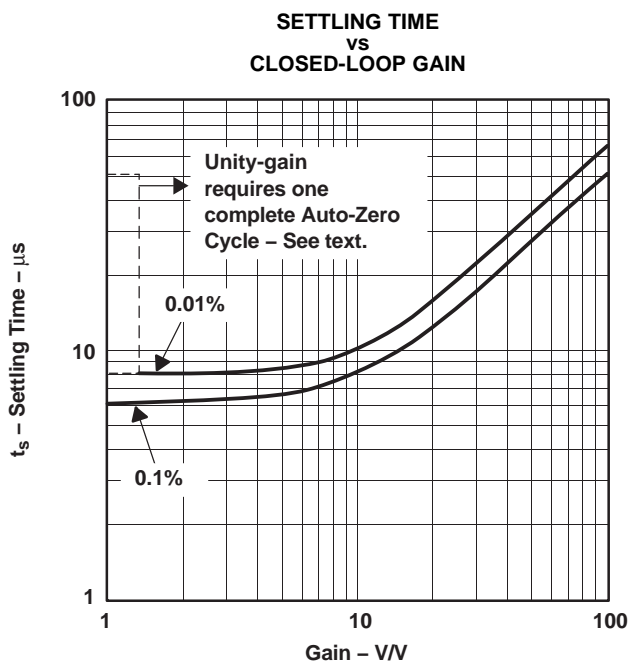


Figure 19.

G019

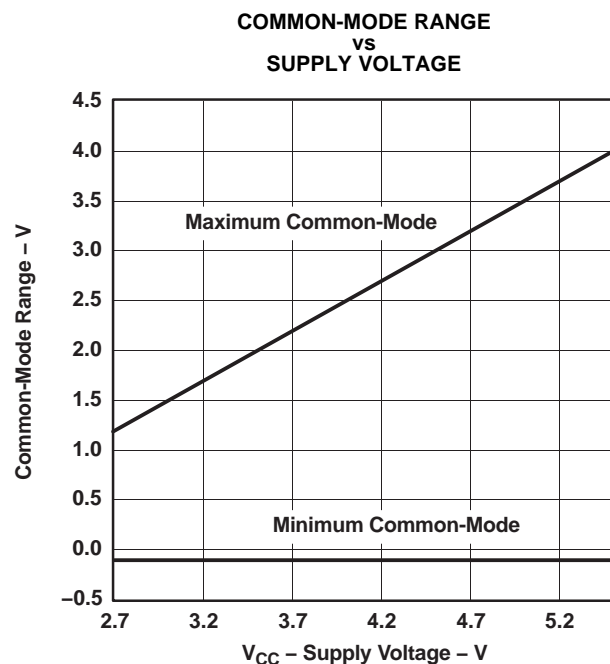


Figure 20.

G020

APPLICATION INFORMATION

The OPA2335 op amp is unity-gain stable and free from unexpected output phase reversal. It uses auto-zeroing techniques to provide low offset voltage and very low drift over time and temperature.

Good layout practice mandates use of a 0.1- μ F capacitor placed closely across the supply pins.

For lowest offset voltage and precision performance, circuit layout and mechanical conditions should be optimized. Avoid temperature gradients that create thermoelectric (Seebeck) effects in thermocouple junctions formed from connecting dissimilar conductors. These thermally-generated potentials can be made to cancel by assuring that they are equal on both input terminals.

- Use low thermoelectric-coefficient connections (avoid dissimilar metals).
- Thermally isolate components from power supplies or other heat-sources.
- Shield op amp and input circuitry from air currents, such as cooling fans.

Following these guidelines will reduce the likelihood of junctions being at different temperatures, which can cause thermoelectric voltages of 0.1 μ V/ $^{\circ}$ C or higher, depending on materials used.

OPERATING VOLTAGE

The OPA2335 op amp operates over a power-supply range of 2.7 V to 5.5 V (± 1.35 V to ± 2.75 V). Supply voltages higher than 7 V (absolute maximum) can permanently damage the amplifier. Parameters that vary over supply voltage or temperature are shown in the Typical Characteristics section of this data sheet.

INPUT VOLTAGE

The input common-mode range extends from $(V-) - 0.1$ V to $(V+) - 1.5$ V. For normal operation, the inputs must be limited to this range. The common-mode rejection ratio is only valid within the valid input common-mode range. A lower supply voltage results in lower input common-mode range; therefore, attention to these values must be given when selecting the input bias voltage. For example, when operating on a single 3-V power supply, common-mode range is from 0.1 V below ground to half the power-supply voltage.

Normally, input bias current is approximately 70 pA; however, input voltages exceeding the power supplies can cause excessive current to flow in or out of the input pins. Momentary voltages greater than the power supply can be tolerated if the input current is limited to 10 mA. This is easily accomplished with an input resistor, as shown in Figure 21.

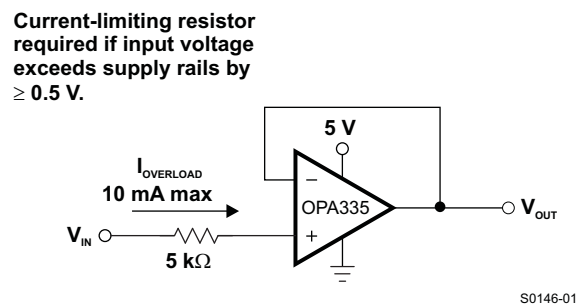


Figure 21. Input Current Protection

INTERNAL OFFSET CORRECTION

The OPA2335 op amp uses an auto-zero topology with a time-continuous 2-MHz op amp in the signal path. This amplifier is zero-corrected every 100 μ s using a proprietary technique. Upon power-up, the amplifier requires one full auto-zero cycle of approximately 100 μ s to achieve specified V_{OS} accuracy. Prior to this time, the amplifier functions properly, but with unspecified offset voltage.

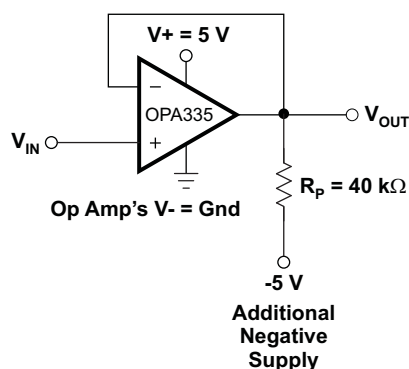
This design has remarkably little aliasing and noise. Zero correction occurs at a 10-kHz rate, but there is virtually no fundamental noise energy present at that frequency. For all practical purposes, any glitches have energy at 20 MHz or higher and are easily filtered, if required. Most applications are not sensitive to such high-frequency noise, and no filtering is required.

APPLICATION INFORMATION (continued)

Unity-gain operation demands that the auto-zero circuitry correct for common-mode rejection errors of the main amplifier. Because these errors can be larger than 0.01% of a full-scale input step change, one calibration cycle (100 μ s) can be required to achieve full accuracy. This behavior is shown in the typical characteristic section, see *Settling Time vs Closed-Loop Gain*.

ACHIEVING OUTPUT SWING TO THE OP AMP'S NEGATIVE RAIL

Some applications require output voltage swing from 0 V to a positive full-scale voltage (such as 2.5 V) with excellent accuracy. With most single-supply op amps, problems arise when the output signal approaches 0 V, near the lower output swing limit of a single-supply op amp. A good single-supply op amp may swing close to single-supply ground, but will not reach ground. The output of the OPA2335 can be made to swing to ground, or slightly below, on a single-supply power source. To do so requires use of another resistor and an additional, more negative, power supply than the op amp's negative supply. A pull-down resistor may be connected between the output and the additional negative supply to pull the output down below the value that the output would otherwise achieve, as shown in [Figure 22](#).



S0147-01

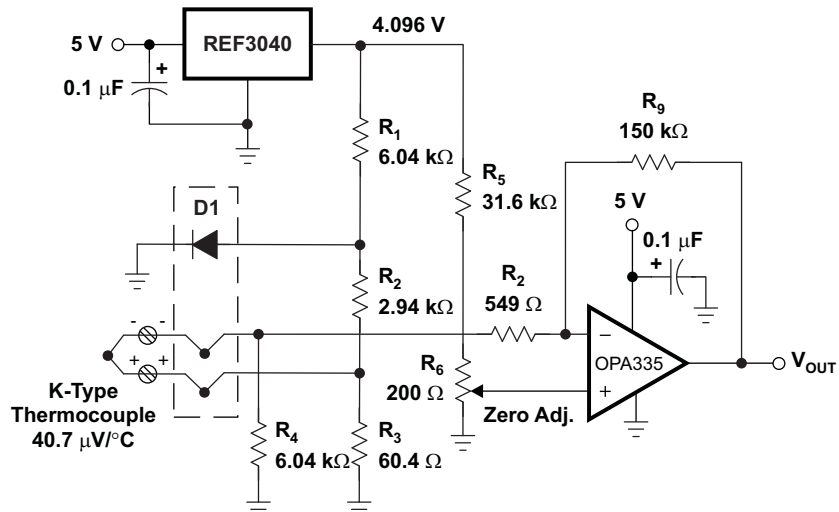
Figure 22. Op Amp With Pull-Down Resistor to Achieve $V_{OUT} = \text{Ground}$

The OPA2335 has an output stage that allows the output voltage to be pulled to its negative supply rail, or slightly below using the above technique. This technique only works with some types of output stages. The OPA2335 has been characterized to perform well with this technique. Accuracy is excellent down to 0 V and as low as -2 mV. Limiting and non-linearity occurs below -2 mV, but excellent accuracy returns as the output is again driven above -2 mV. Lowering the resistance of the pull-down resistor allows the op amp to swing even further below the negative rail. Resistances as low as 10 k Ω can be used to achieve excellent accuracy, down to -10 mV.

LAYOUT GUIDELINES

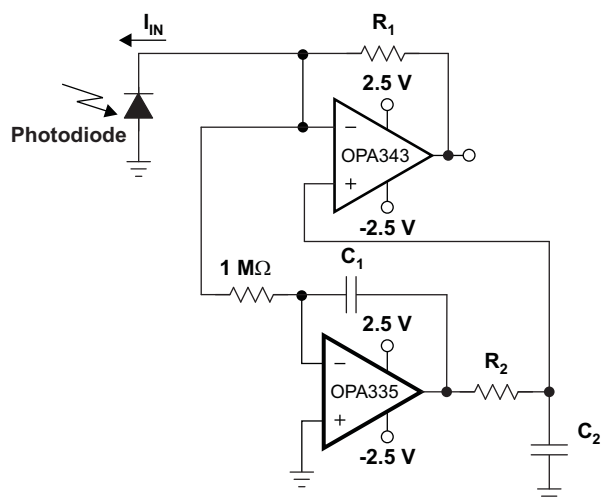
Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1- μ F capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits, such as reducing the EMI (electromagnetic-interference) susceptibility.

APPLICATION INFORMATION (continued)

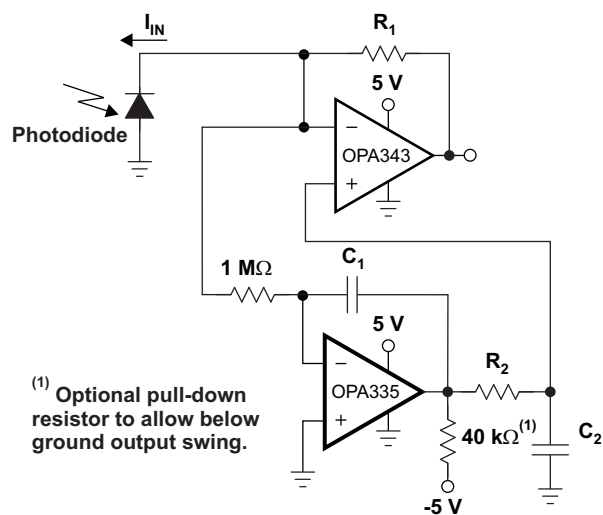


S0148-01

Figure 23. Temperature Measurement Circuit



a. Split Supply

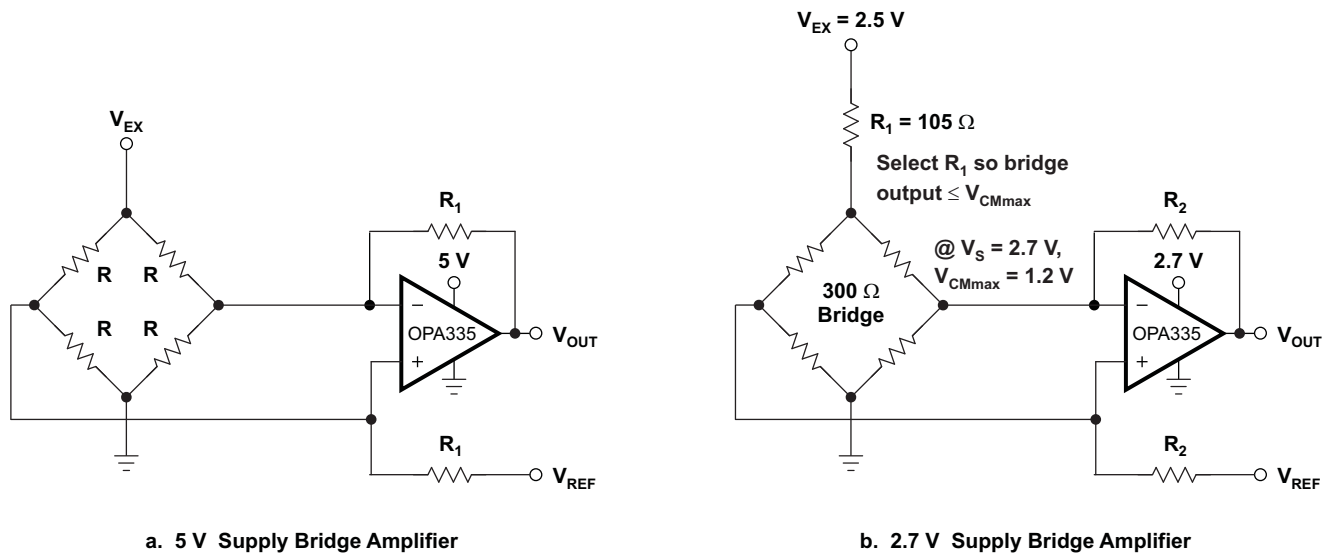


b. Single Supply

S0149-01

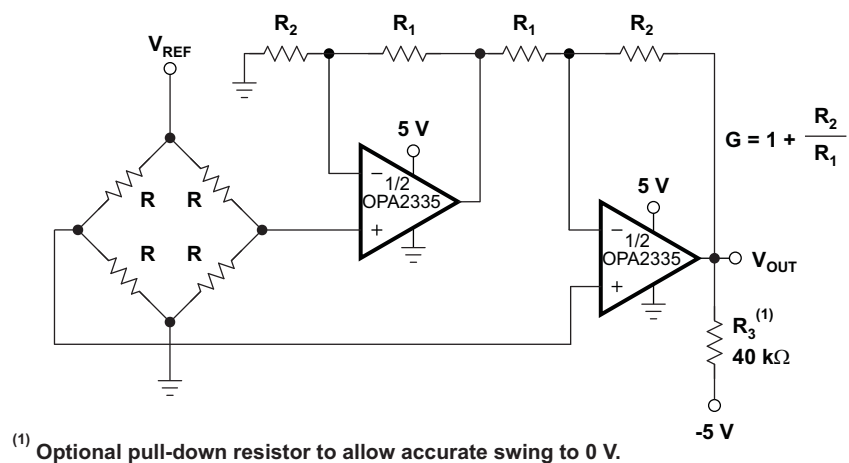
Figure 24. Auto-Zeroed Transimpedance Amplifier

APPLICATION INFORMATION (continued)



S0150-01

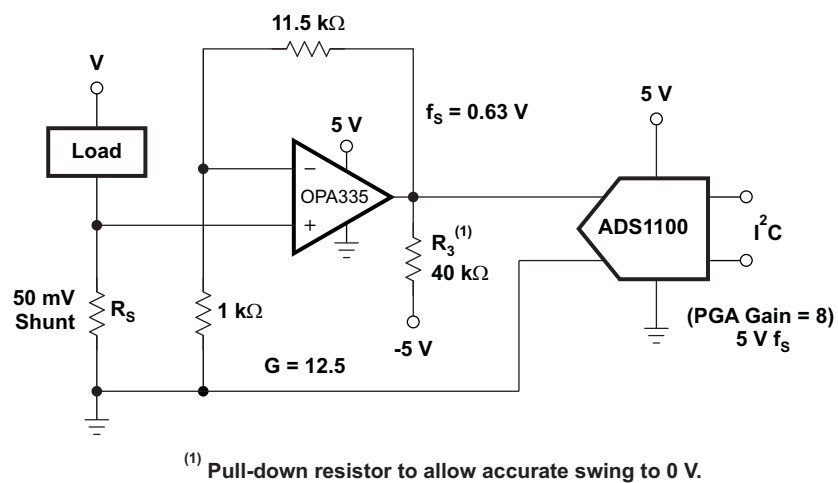
Figure 25. Single Op-Amp Bridge Amplifier Circuits



S0151-01

Figure 26. Dual Op-Amp IA Bridge Amplifier

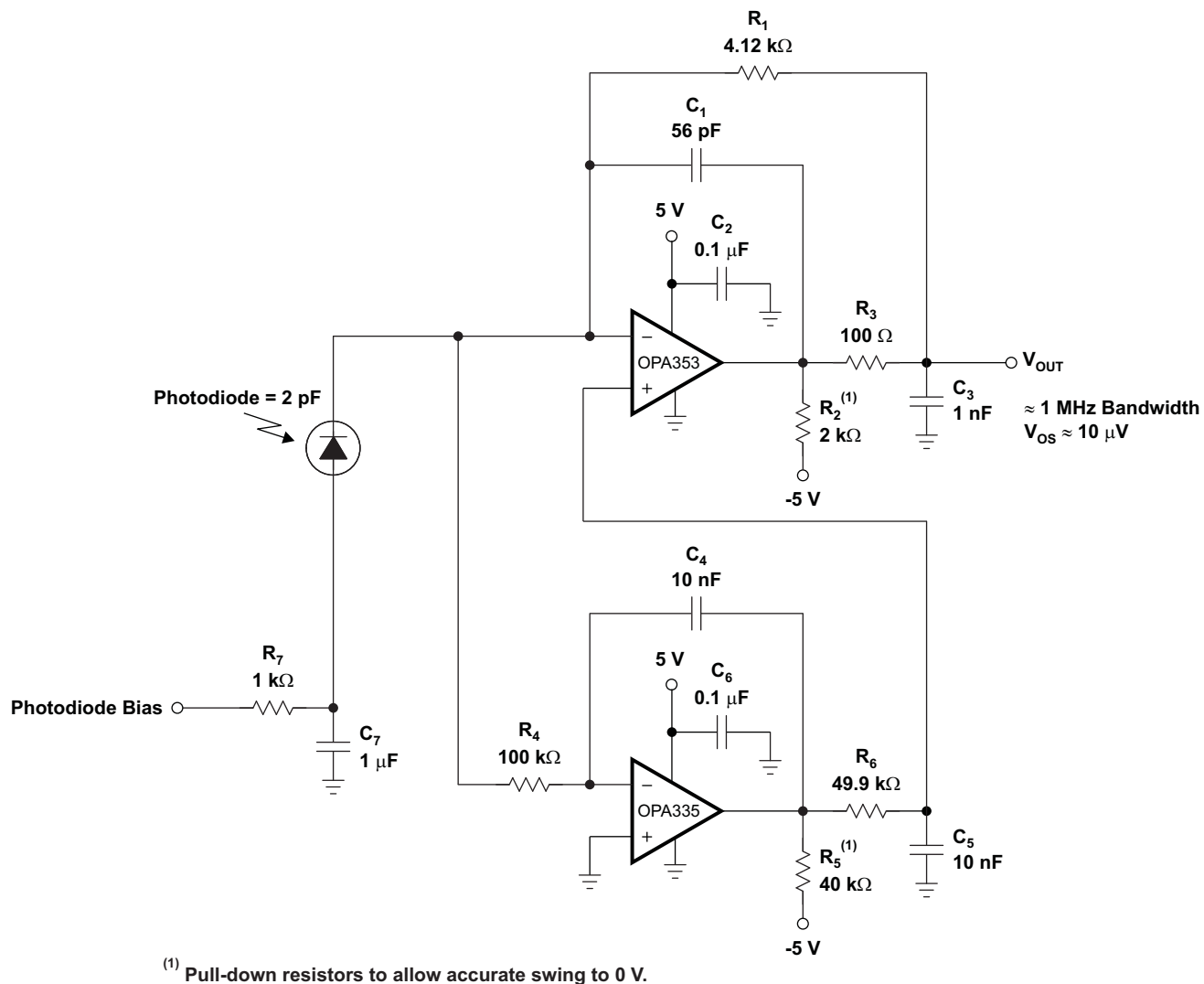
APPLICATION INFORMATION (continued)



S0152-01

Figure 27. Low-Side Current Measurement

APPLICATION INFORMATION (continued)



S0153-01

Figure 28. High Dynamic-Range Transimpedance Amplifier

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification.
 - E. Falls within MIL STD 1835 GDIP1-T8

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| OPA2335AMJG | Active | Production | CDIP (JG) 8 | 50 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | OPA2335AMJG |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF OPA2335M :

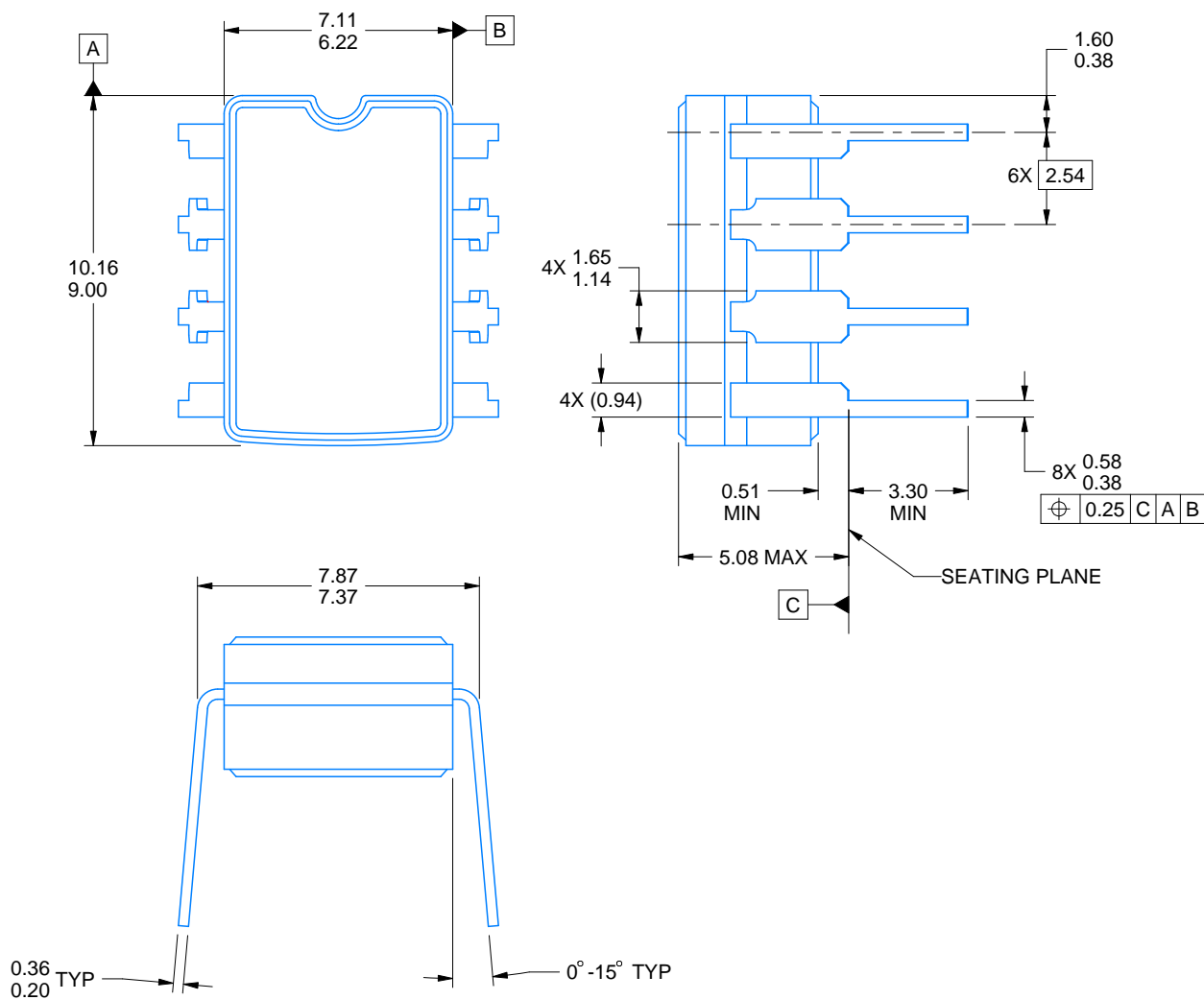
- Catalog : [OPA2335](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

JG0008A**PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN-LINE PACKAGE



4230036/A 09/2023

NOTES:

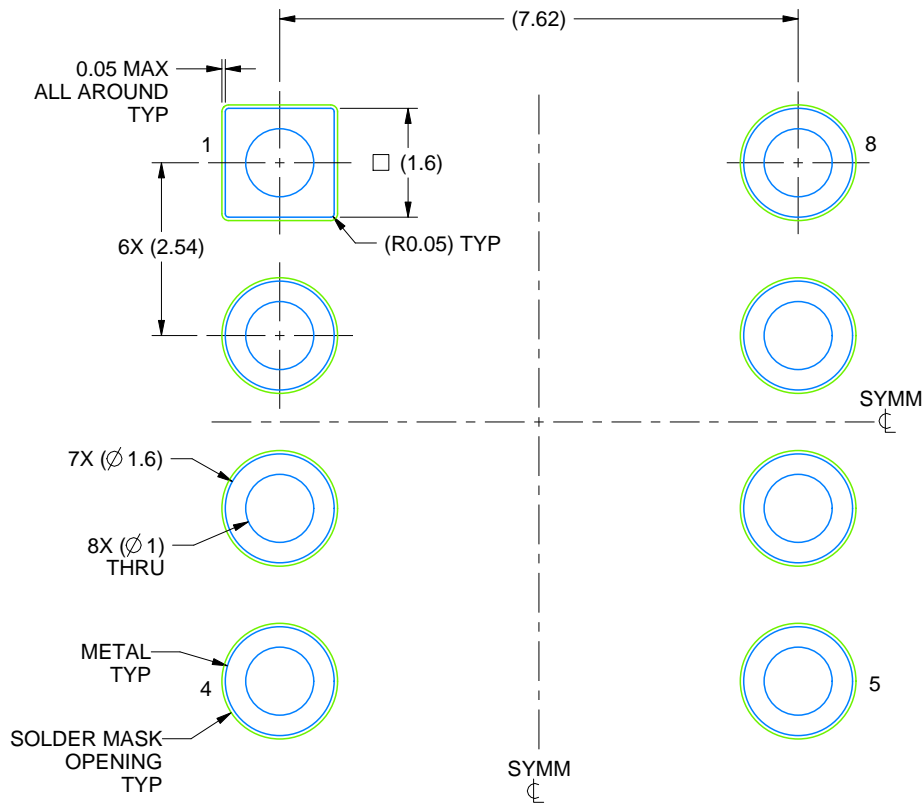
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package can be hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification.
5. Falls within MIL STD 1835 GDIP1-T8

EXAMPLE BOARD LAYOUT

JG0008A

CDIP - 5.08 mm max height

CERAMIC DUAL IN-LINE PACKAGE



LAND PATTERN EXAMPLE
NON SOLDER MASK DEFINED
SCALE: 9X

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